

(1.27 mm) .050"

## & THROUGH-HOLE TIGER EYE" SOCKET

## **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?SFM or www.samtec.com?SFML

Insulator Material: Black Liquid Crystal Polymer

Plating:

Au or Sn over 50µ" (1.27 µm) Ni Current Rating (SFM/TFM): 3.2 A per pin (1 pin powered per row)

Voltage Rating: 250 VAC mated with TFM Operating Temp Range:

-55°C to +125°C
Contact Resistance: 15 m $\Omega$ 

Insertion Depth: (3.05 mm) .120" to (4.06 mm) .160"

Wiping Distance: (0.38 mm) .015" Normal Force:

Normal Force: Standard= 132 g (1.29 N) avg.; LIF= 90 g (0.88 N) avg. Insertion Force (SFM): (Single contact only) Standard= 2.5 oz (0.69 N) avg.; LITE= 2.0 oz (0.56 N) avg.;

LIF= 1.4 oz (0.39 N) avg. Withdrawal Force (SFM): Standard= 2.0 oz (0.56 N) avg.; LITE= 1.5 oz (0.42 N) avg.; LIF= 1.0 oz (0.28 N) avg.

Max Cycles: 10,000 with 30μ" (0.76 μm) Au

(Call Samtec for E.L.P. plating option)
RoHS Compliant:

**Processing:** 

Lead-Free Solderable: Yes

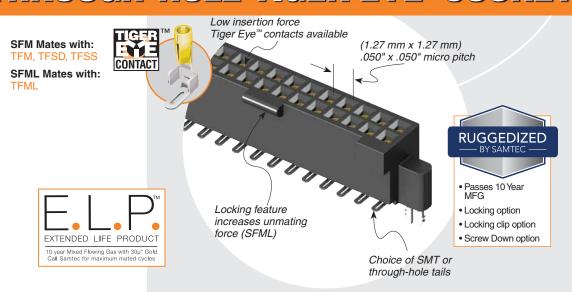
SMT Lead Coplanarity: (0.10 mm) .004" max (05-25) (0.15 mm) .006" max (30-50)

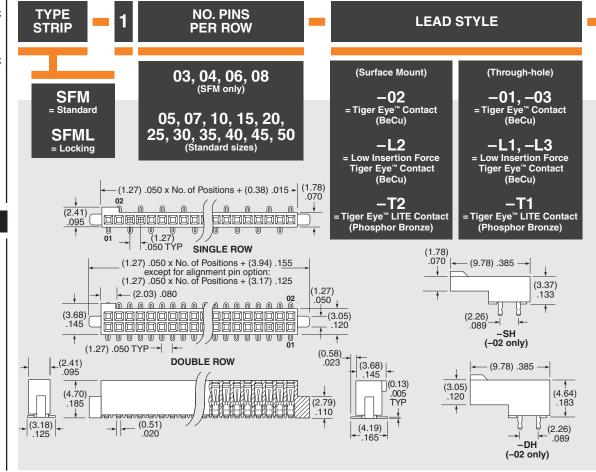
## RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

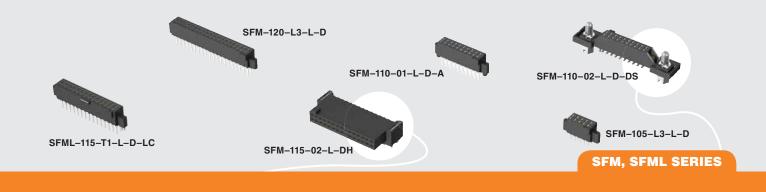


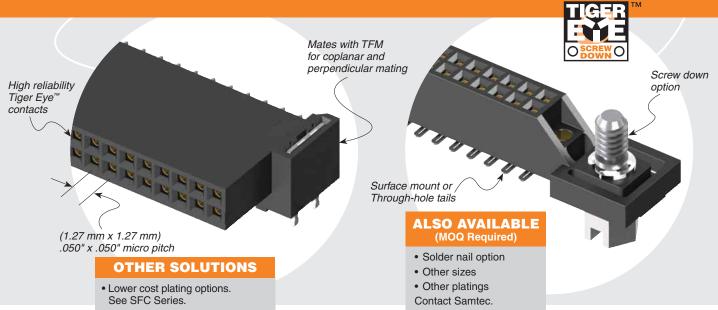


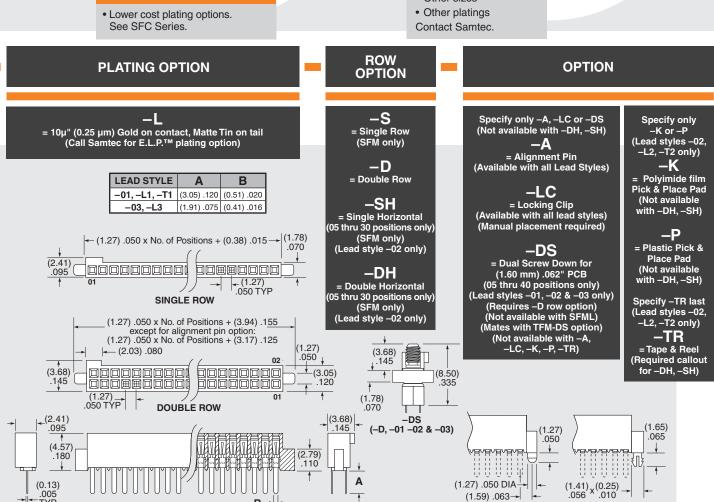




Note: Some sizes, styles and options are non-standard, non-returnable







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